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P/2292-29

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of
Seok-Keun KOH, et al.
Serial No.: 09/509,725
Filed: March 29, 2000
New York, New York
Date: October 29, 2002
Group Art Unit: 1714
Examiner: Kishor MAYEKAR
For: PLASMA POLYMERIZATION ON SURFACE OF MATERIAL

12/B
17/5/2

Hon. Commissioner of Patents and Trademarks
Washington, D.C. 20231

AMENDMENT/SUBMISSION

This is a response to the Office Action mailed July 30, 2002 in the above-identified application. Reconsideration of the application is respectfully requested.

FEE CALCULATION

Any additional fee required has been calculated as follows:

☒ If checked, "Small Entity" status is claimed.

NO. CLAIMS AFTER AMENDMENT		HIGHEST NO. PREVIOUSLY PAID FOR		EXTRA PRESENT		RATE		ADDIT. FEE
TOTAL	31	MINUS	32	* =	0	X	(\$9 SE or \$18)	\$0
INDEP.	4	MINUS	4	** =	0	X	(\$42 SE or \$84)	\$0
FIRST PRESENTATION OF MULTIPLE DEPENDENT CLAIM						X	(\$140 SE or \$280)	\$0

* not less than 20 ** not less than 3 TOTAL \$ 0

If any additional payment is required, a check which includes the calculated fee of \$ _____
(OFGS Check No. _____) is attached.

In the event the actual fee is greater than the payment submitted or is inadvertently not enclosed or if any additional fee during the prosecution of this application is not paid, the Patent Office is authorized to charge the underpayment to Deposit Account No. 15-0700.